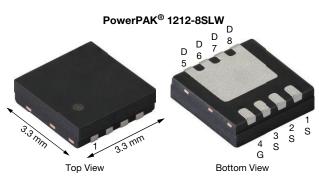
## SQS174ELNW

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**Vishay Siliconix** 

# Automotive N-Channel 72 V (D-S) 175 °C MOSFET

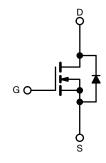


Marking code: Q045

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	72			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0055			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.0072			
I <sub>D</sub> (A) <sup>e</sup>	87			
Configuration	Single			

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



N-Channel MOSFET

ORDERING INFORMATION				
Package	PowerPAK <sup>®</sup> 1212-8SLW			
Lead (Pb)-free and halogen-free	SQS174ELNW (for detailed order number please see <u>www.vishay.com/doc?79771</u> )			

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage	source voltage		72	V	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
Continuous drain current <sup>e</sup>	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	87		
Continuous drain current °	T <sub>C</sub> = 125 °C		50		
Continuous source current (diode conduction) <sup>e</sup> Pulsed drain current <sup>a</sup>		I <sub>S</sub>	94	А	
		I <sub>DM</sub>	219		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	29		
Single pulse avalanche energy	L = 0.1 IIIH	E <sub>AS</sub>	42	mJ	
Maximum neuror dissinction a	$T_{\rm C} = 25 ^{\circ}{\rm C}$	D	103	W	
Maximum power dissipation <sup>a</sup>	T <sub>C</sub> = 125 °C	P <sub>D</sub>	34	vv	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature)	-	260	-0		
THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>b</sup>	R <sub>thJA</sub>	54	20 AN	
Junction-to-case (drain) d		R <sub>thJC</sub>	1.45	°C/W	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. When mounted on 1" square PCB (FR4 material)

See solder profile (www.vishay.com/doc?73257). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure c. adequate bottom side solder interconnection

d. As per on JESD51-14

e. Values based on Rth.IC and TC of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system 1

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•			·		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		72	-	-	v
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		1.2	1.7	2.5	v
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 72 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 72 V, T <sub>J</sub> = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 72 V, T <sub>J</sub> = 175 °C	-	-	150	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	20	-	-	Α
		V <sub>GS</sub> = 4.5 V		-	0.0050	0.0072	- Ω
5	-	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A	-	0.0038	0.0055	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C	-	-	0.0089	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C	-	-	0.0113	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 50 A	-	140	-	S
Dynamic <sup>b</sup>		<b></b>			I	I	
Input capacitance	C <sub>iss</sub>			-	2623	3654	03 pF
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 25 V, f = 1 MHz	-	502	703	
Reverse transfer capacitance	C <sub>rss</sub>			-	33	47	
Total gate charge <sup>c</sup>	Qg		V <sub>GS</sub> = 10 V V <sub>DS</sub> = 30 V, I <sub>D</sub> = 4 A	-	46	69	nC
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	8	-	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	8	-	-
Gate resistance	R <sub>g</sub>		f = 1 MHz	0.3	1.0	1.6	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>				12	18	
Rise time <sup>c</sup>	t <sub>r</sub>	- V_D =	30 V, R <sub>I</sub> = 14.4 Ω,	-	4	8	1
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 2.5 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{R}_g = 1 \Omega$		-	31	47	- ns
Fall time <sup>c</sup>	t <sub>f</sub>			-	17	26	
Source-Drain Diode Ratings and Charac	teristic <sup>b</sup>						
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	192	Α
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V		-	0.82	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>	$V_{DD} = 48$ V, I <sub>FM</sub> = 3 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	35	70	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	43	86	nC
Reverse recovery fall time	t <sub>a</sub>			-	26	-	
Reverse recovery rise time	t <sub>b</sub>			-	9	-	ns
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			_	-2.1	_	A

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

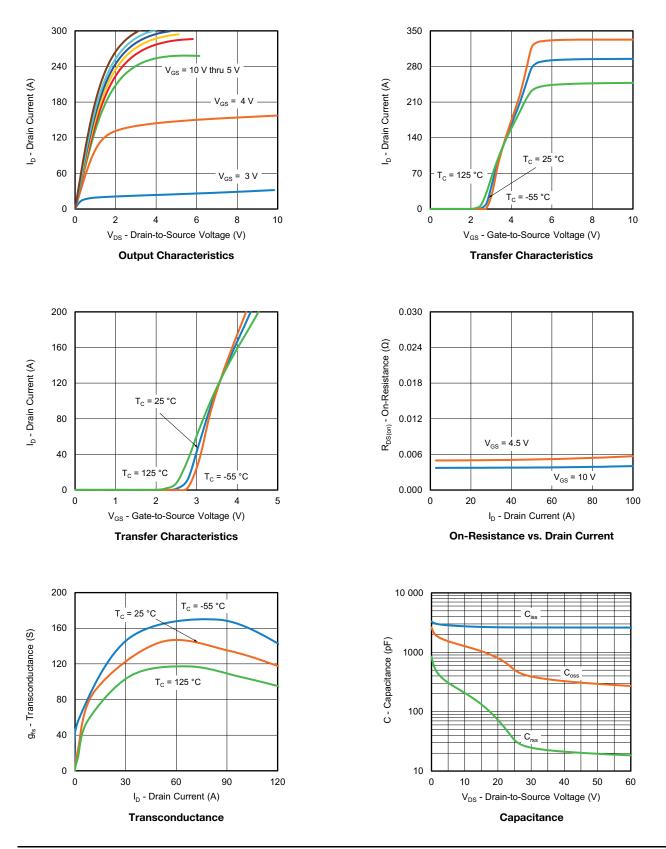
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



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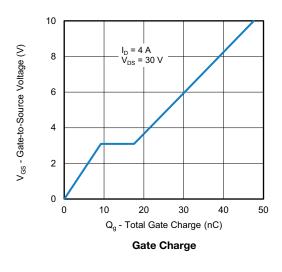
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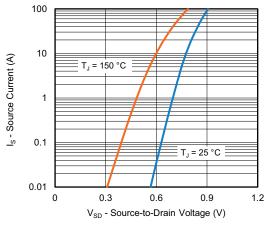
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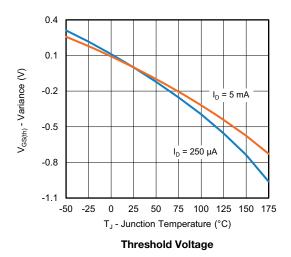
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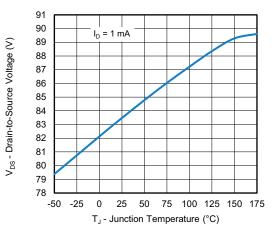
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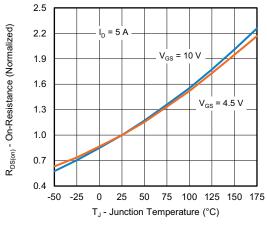


Source Drain Diode Forward Voltage

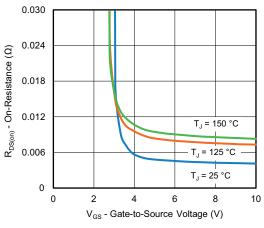




Drain Source Breakdown vs. Junction Temperature



**On-Resistance vs. Junction Temperature** 



**On-Resistance vs. Gate-to-Source Voltage** 

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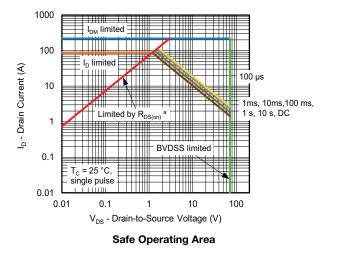
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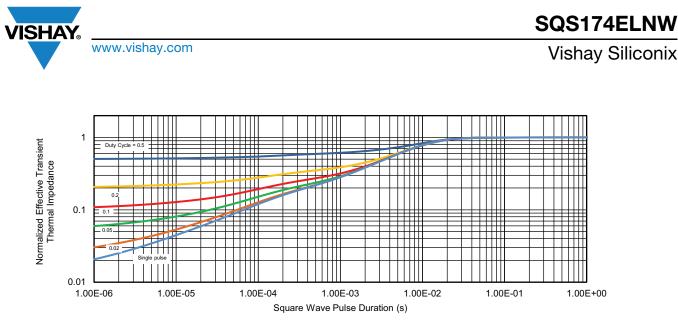
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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)

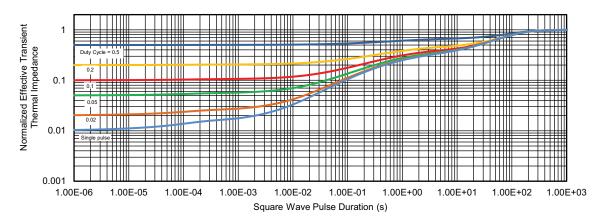


#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



Normalized Thermal Transient Impedance, Junction-to-Case





#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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